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[International Rectifier \(Infineon Technologies Americas Corp.\)  
IRG4PC50F-EPBF](#)

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# International IR Rectifier

PD - 96168

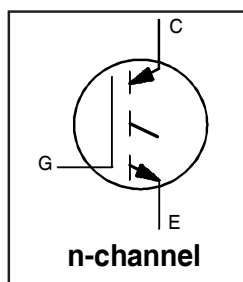
## IRG4PC50F-EPbF

INSULATED GATE BIPOLAR TRANSISTOR

Fast Speed IGBT

### Features

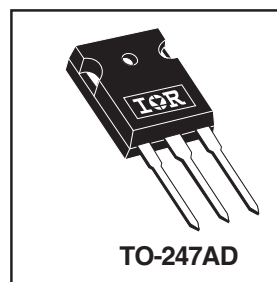
- Optimized for medium operating frequencies ( 1-5 kHz in hard switching, >20 kHz in resonant mode).
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- Industry standard TO-247AD package
- Lead-Free



|                             |
|-----------------------------|
| $V_{CES} = 600V$            |
| $V_{CE(on) typ.} = 1.45V$   |
| @ $V_{GE} = 15V, I_C = 39A$ |

### Benefits

- Generation 4 IGBT's offer highest efficiency available
- IGBT's optimized for specified application conditions
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBT's



### Absolute Maximum Ratings

|                           | Parameter                              | Max.                              | Units |
|---------------------------|--|-----------------------------------|-------|
| $V_{CES}$                 | Collector-to-Emitter Breakdown Voltage | 600                               | V     |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current           | 70                                | A     |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current           | 39                                |       |
| $I_{CM}$                  | Pulsed Collector Current ①             | 280                               |       |
| $I_{LM}$                  | Clamped Inductive Load Current ②       | 280                               |       |
| $V_{GE}$                  | Gate-to-Emitter Voltage                | $\pm 20$                          | V     |
| $E_{ARV}$                 | Reverse Voltage Avalanche Energy ③     | 20                                | mJ    |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation              | 200                               | W     |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation              | 78                                |       |
| $T_J$                     | Operating Junction and                 | -55 to + 150                      | °C    |
| $T_{STG}$                 | Storage Temperature Range              |                                   |       |
|                           | Soldering Temperature, for 10 seconds  | 300 (0.063 in. (1.6mm from case ) |       |
|                           | Mounting torque, 6-32 or M3 screw.     | 10 lbf•in (1.1N•m)                |       |

### Thermal Resistance

|                 | Parameter                                 | Typ.     | Max. | Units  |
|-----------------|---|----------|------|--------|
| $R_{\theta JC}$ | Junction-to-Case                          | —        | 0.64 | °C/W   |
| $R_{\theta CS}$ | Case-to-Sink, Flat, Greased Surface       | 0.24     | —    |        |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —        | 40   |        |
| $Wt$            | Weight                                    | 6 (0.21) | —    | g (oz) |

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## Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

|  | Parameter                                | Min. | Typ. | Max. | Units | Conditions   |
|--|--|------|------|------|-------|--|
| V <sub>(BR)CES</sub>                   | Collector-to-Emitter Breakdown Voltage   | 600  | —    | —    | V     | V <sub>GE</sub> = 0V, I <sub>C</sub> = 250μA   |
| V <sub>(BR)ECS</sub>                   | Emitter-to-Collector Breakdown Voltage ④ | 18   | —    | —    | V     | V <sub>GE</sub> = 0V, I <sub>C</sub> = 1.0A  |
| ΔV <sub>(BR)CES</sub> /ΔT <sub>J</sub> | Temperature Coeff. of Breakdown Voltage  | —    | 0.62 | —    | V/°C  | V <sub>GE</sub> = 0V, I <sub>C</sub> = 1.0mA   |
| V <sub>CE(ON)</sub>                    | Collector-to-Emitter Saturation Voltage  | —    | 1.45 | 1.6  | V     | I <sub>C</sub> = 39A<br>I <sub>C</sub> = 70A<br>I <sub>C</sub> = 39A, T <sub>J</sub> = 150°C<br>V <sub>GE</sub> = 15V<br>See Fig.2, 5  |
|  |  | —    | 1.79 | —    |       |  |
|  |  | —    | 1.53 | —    |       |  |
| V <sub>GE(th)</sub>                    | Gate Threshold Voltage                   | 3.0  | —    | 6.0  |       | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA   |
| ΔV <sub>GE(th)</sub> /ΔT <sub>J</sub>  | Temperature Coeff. of Threshold Voltage  | —    | -14  | —    | mV/°C | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250μA   |
| g <sub>fe</sub>                        | Forward Transconductance ⑤               | 21   | 30   | —    | S     | V <sub>CE</sub> = 100V, I <sub>C</sub> = 39A   |
| I <sub>CES</sub>                       | Zero Gate Voltage Collector Current      | —    | —    | 250  | μA    | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V<br>V <sub>GE</sub> = 0V, V <sub>CE</sub> = 10V, T <sub>J</sub> = 25°C<br>V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V, T <sub>J</sub> = 150°C |
|  |  | —    | —    | 2.0  |       |  |
|  |  | —    | —    | 2000 |       |  |
| I <sub>GES</sub>                       | Gate-to-Emitter Leakage Current          | —    | —    | ±100 | nA    | V <sub>GE</sub> = ±20V   |

## Switching Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

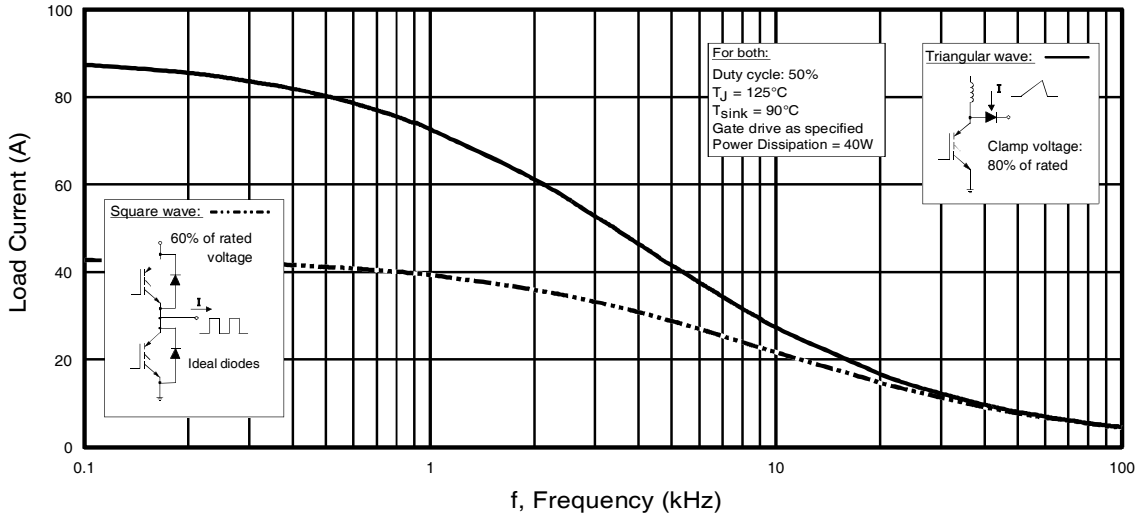
|                     | Parameter                         | Min. | Typ. | Max. | Units | Conditions   |
|---------------------|-----------------------------------|------|------|------|-------|--|
| Q <sub>g</sub>      | Total Gate Charge (turn-on)       | —    | 190  | 290  | nC    | I <sub>C</sub> = 39A<br>V <sub>CC</sub> = 400V<br>V <sub>GE</sub> = 15V<br>See Fig. 8  |
| Q <sub>ge</sub>     | Gate - Emitter Charge (turn-on)   | —    | 28   | 42   |       |  |
| Q <sub>gc</sub>     | Gate - Collector Charge (turn-on) | —    | 65   | 97   |       |  |
| t <sub>d(on)</sub>  | Turn-On Delay Time                | —    | 31   | —    | ns    | T <sub>J</sub> = 25°C<br>I <sub>C</sub> = 39A, V <sub>CC</sub> = 480V<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 5.0Ω<br>Energy losses include "tail"<br>See Fig. 10, 11, 13, 14 |
| t <sub>r</sub>      | Rise Time                         | —    | 25   | —    |       |  |
| t <sub>d(off)</sub> | Turn-Off Delay Time               | —    | 240  | 350  |       |  |
| t <sub>f</sub>      | Fall Time                         | —    | 130  | 190  |       |  |
| E <sub>on</sub>     | Turn-On Switching Loss            | —    | 0.37 | —    | mJ    | See Fig. 10, 11, 13, 14  |
| E <sub>off</sub>    | Turn-Off Switching Loss           | —    | 2.1  | —    |       |  |
| E <sub>ts</sub>     | Total Switching Loss              | —    | 2.47 | 3.0  |       |  |
| t <sub>d(on)</sub>  | Turn-On Delay Time                | —    | 28   | —    | ns    | T <sub>J</sub> = 150°C,<br>I <sub>C</sub> = 39A, V <sub>CC</sub> = 480V<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 5.0Ω<br>Energy losses include "tail"<br>See Fig. 13, 14       |
| t <sub>r</sub>      | Rise Time                         | —    | 24   | —    |       |  |
| t <sub>d(off)</sub> | Turn-Off Delay Time               | —    | 390  | —    |       |  |
| t <sub>f</sub>      | Fall Time                         | —    | 230  | —    |       |  |
| E <sub>ts</sub>     | Total Switching Loss              | —    | 5.0  | —    | mJ    | See Fig. 13, 14  |
| L <sub>E</sub>      | Internal Emitter Inductance       | —    | 13   | —    | nH    | Measured 5mm from package  |
| C <sub>ies</sub>    | Input Capacitance                 | —    | 4100 | —    | pF    | V <sub>GE</sub> = 0V<br>V <sub>CC</sub> = 30V<br>f = 1.0MHz<br>See Fig. 7  |
| C <sub>oes</sub>    | Output Capacitance                | —    | 250  | —    |       |  |
| C <sub>res</sub>    | Reverse Transfer Capacitance      | —    | 49   | —    |       |  |

### Notes:

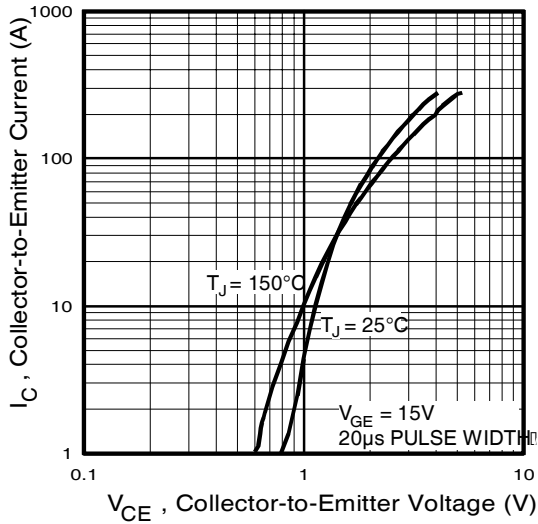
- ① Repetitive rating; V<sub>GE</sub> = 20V, pulse width limited by max. junction temperature. ( See fig. 13b )
- ② V<sub>CC</sub> = 80%(V<sub>CES</sub>), V<sub>GE</sub> = 20V, L = 10μH, R<sub>G</sub> = 5.0Ω, (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width ≤ 80μs; duty factor ≤ 0.1%.
- ⑤ Pulse width 5.0μs, single shot.

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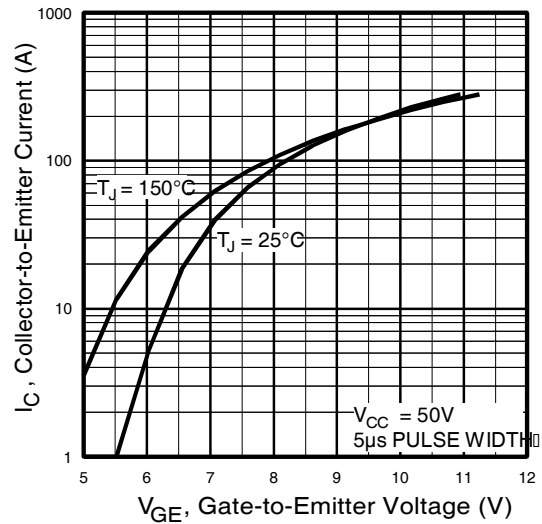
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**Fig. 1 - Typical Load Current vs. Frequency**  
 (For square wave,  $I = I_{RMS}$  of fundamental; for triangular wave,  $I = I_{PK}$ )



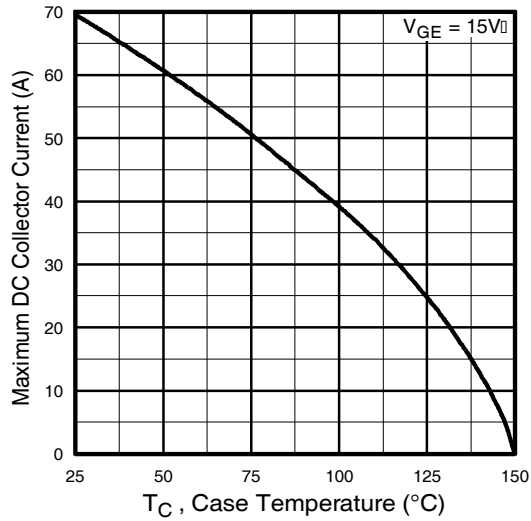
**Fig. 2 - Typical Output Characteristics**



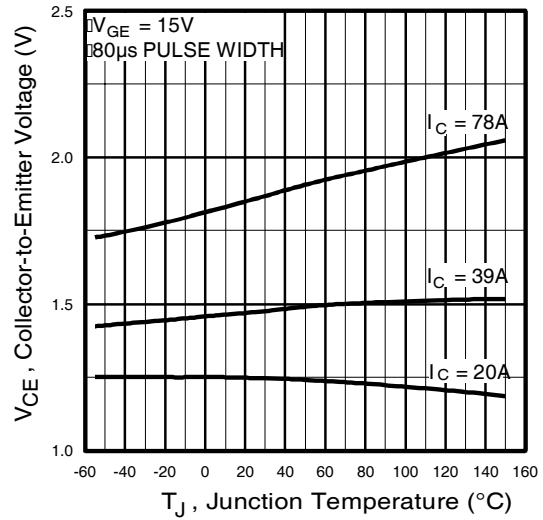
**Fig. 3 - Typical Transfer Characteristics**

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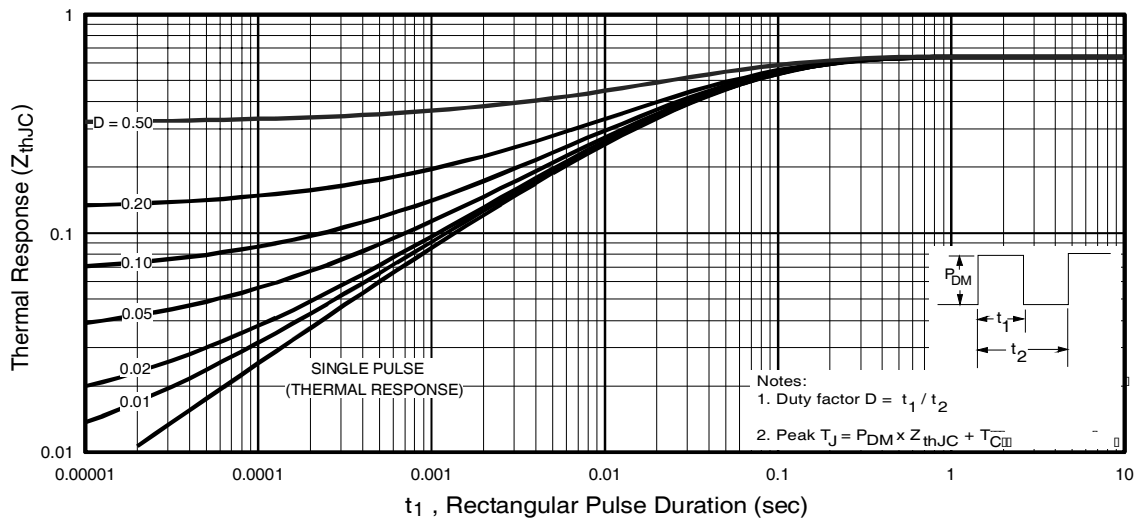
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**Fig. 4 - Maximum Collector Current vs. Case Temperature**



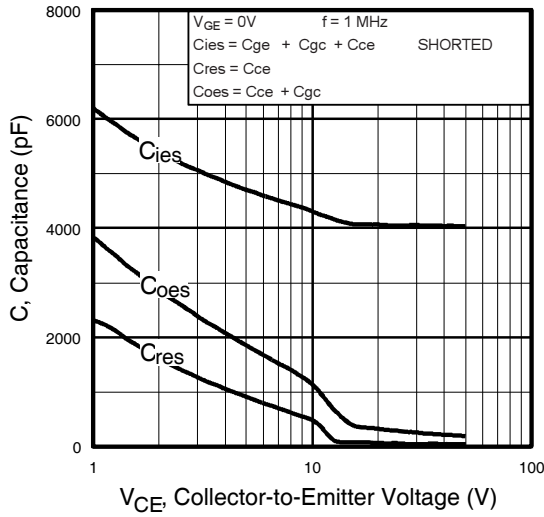
**Fig. 5 - Collector-to-Emitter Voltage vs. Junction Temperature**



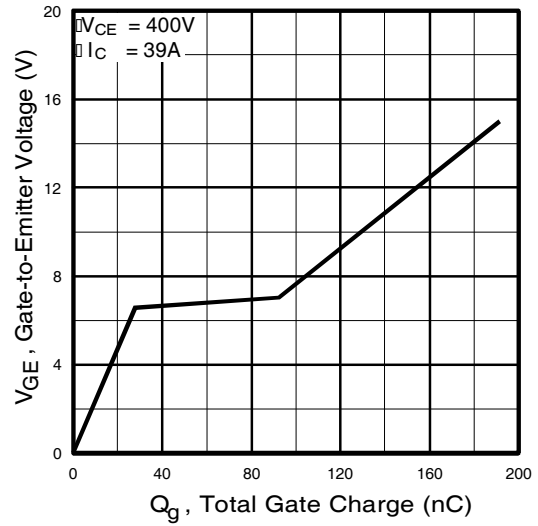
**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

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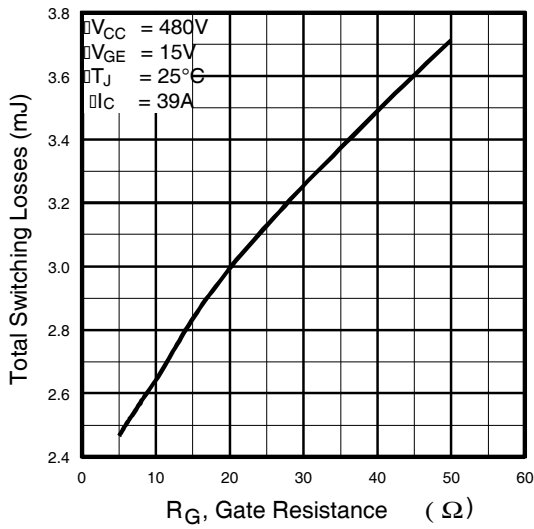
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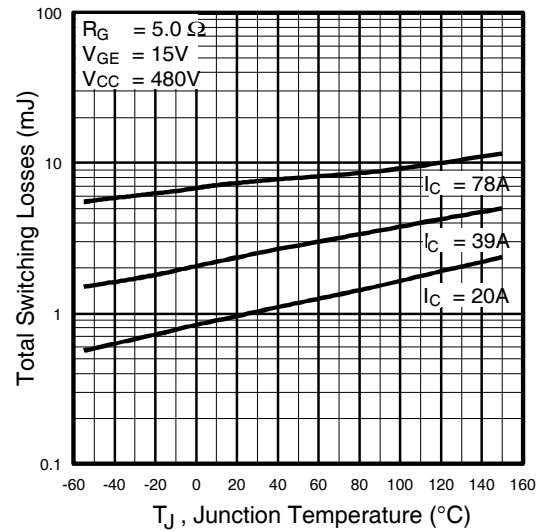
**Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage**



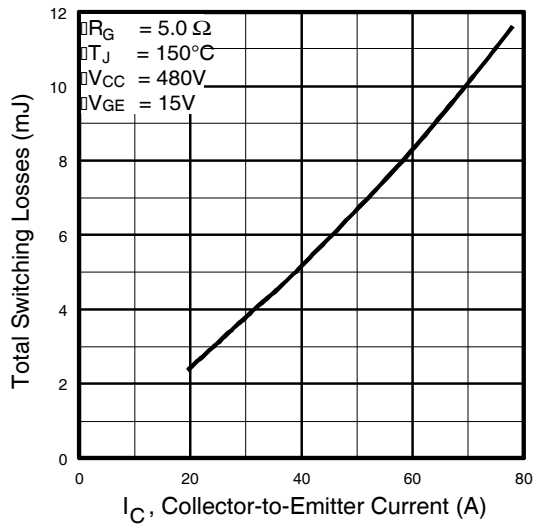
**Fig. 9 - Typical Switching Losses vs. Gate Resistance**



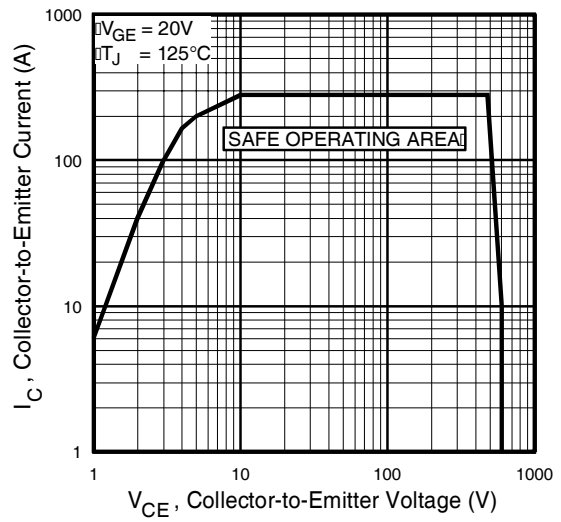
**Fig. 10 - Typical Switching Losses vs. Junction Temperature**

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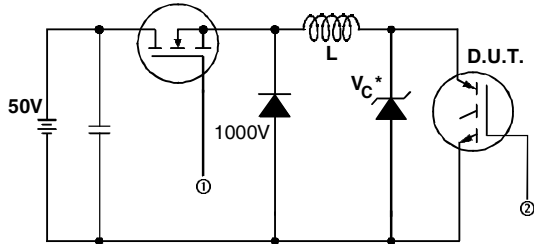
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



**Fig. 12** - Turn-Off SOA

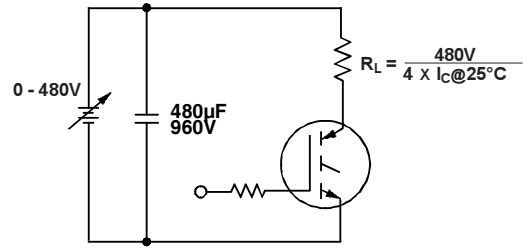
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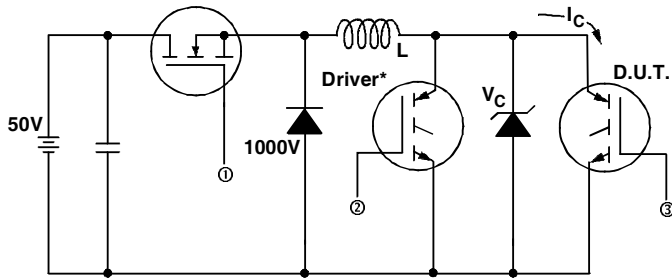


\* Driver same type as D.U.T.;  $V_c = 80\%$  of  $V_{ce(max)}$   
 \* Note: Due to the 50V power supply, pulse width and inductor will increase to obtain rated  $I_d$ .

**Fig. 13a** - Clamped Inductive Load Test Circuit

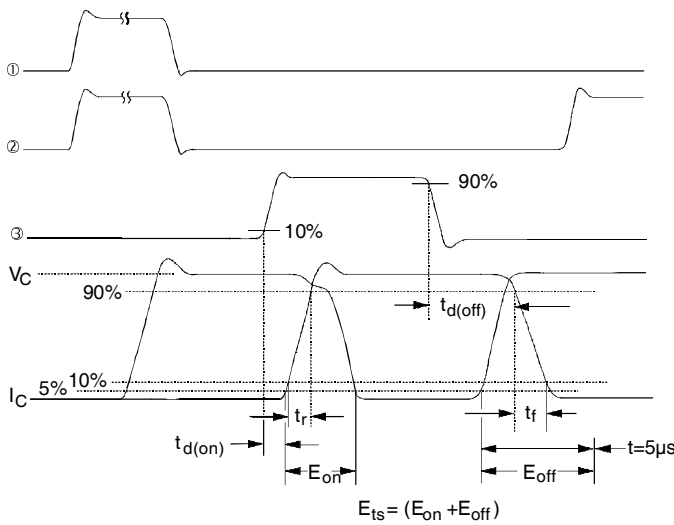


**Fig. 13b** - Pulsed Collector Current Test Circuit



**Fig. 14a** - Switching Loss Test Circuit

\* Driver same type as D.U.T.,  $V_c = 480V$



**Fig. 14b** - Switching Loss Waveforms

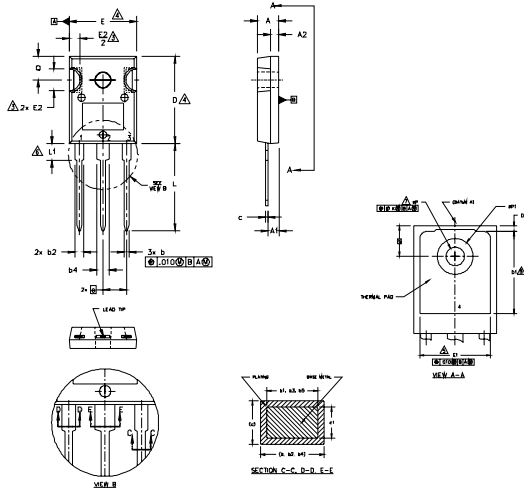


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## TO-247AD Package Outline

Dimensions are shown in millimeters (inches)



**NOTES:**

- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
- DIMENSIONS ARE SHOWN IN INCHES.
- CONTOUR OF SLOT OPTIONAL.
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
- LEAD FINISH UNCONTROLLED IN L1.
- øP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5 ° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
- OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AD.

| SYMBOL | DIMENSIONS |      |             |       | NOTES |
|--------|------------|------|-------------|-------|-------|
|        | INCHES     |      | MILLIMETERS |       |       |
|        | MIN.       | MAX. | MIN.        | MAX.  |       |
| A      | .183       | .209 | 4.65        | 5.31  |       |
| A1     | .087       | .102 | 2.21        | 2.59  |       |
| A2     | .059       | .098 | 1.50        | 2.49  |       |
| b      | .039       | .055 | 0.99        | 1.40  |       |
| b1     | .039       | .053 | 0.99        | 1.35  |       |
| b2     | .065       | .094 | 1.65        | 2.39  |       |
| b3     | .065       | .092 | 1.65        | 2.34  |       |
| b4     | .102       | .135 | 2.59        | 3.45  |       |
| b5     | .102       | .133 | 2.59        | 3.38  |       |
| c      | .015       | .035 | 0.38        | 0.89  |       |
| c1     | .015       | .033 | 0.38        | 0.84  | 4     |
| D      | .776       | .815 | 19.71       | 20.70 | 5     |
| D1     | .515       | -    | 13.08       | -     |       |
| D2     | .020       | .053 | 0.51        | 1.35  | 4     |
| E      | .602       | .625 | 15.29       | 15.87 |       |
| E1     | .530       | -    | 13.46       | -     |       |
| E2     | .178       | .216 | 4.52        | 5.49  |       |
| e      | .215 BSC   |      | 5.46 BSC    |       |       |
| øk     | .010       |      | 0.25        |       |       |
| L      | .780       | .827 | 19.57       | 21.00 |       |
| L1     | .146       | .169 | 3.71        | 4.29  |       |
| øP     | .140       | .144 | 3.56        | 3.66  |       |
| øP1    | -          | .291 | -           | 7.39  |       |
| O      | .209       | .224 | 5.31        | 5.69  |       |
| S      | .217 BSC   |      | 5.51 BSC    |       |       |

**LEAD ASSIGNMENTS**

**HEXFET**

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

**IGBTs, CoPACK**

- 1.- GATE
- 2.- COLLECTOR
- 3.- EMITTER
- 4.- COLLECTOR

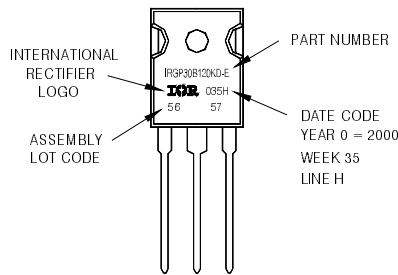
**DIODES**

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE

## TO-247AD Part Marking Information

EXAMPLE: THIS IS AN IRGP30B120KD-E  
 WITH ASSEMBLY  
 LOT CODE 5657  
 ASSEMBLED ON WW 35, 2000  
 IN THE ASSEMBLY LINE 'H'

Note: 'P' in assembly line position  
 indicates 'Lead-Free'



TO-247AD package is not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.

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**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105  
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